TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74LCX540F,TC74LCX540FW,TC74LCX540FT,TC74LCX540FK

Low-Voltage Octal Bus Buffer (inverted) with 5-V Tolerant Inputs and Outputs

The TC74LCX540F/FW/FT/FK is a high-performance CMOS octal bus buffer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

The device is designed for low-voltage  $(3.3\ V)\ VCC$  applications, but it could be used to interface to  $5\ V$  supply environment for both inputs and outputs.

The TC74LCX540F/FW/FT is an inverting 3-state buffer having two active-low output enables. When either  $\overline{OE}1$  or  $\overline{OE}2$  are high, the terminal outputs are in the high-impedance state. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.

#### **Features**

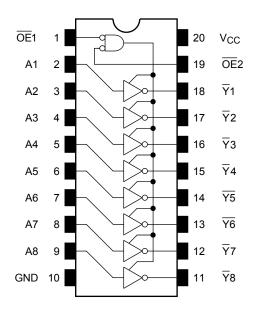
- Low-voltage operation: VCC = 2.0 to 3.6 V
- High-speed operation:  $t_{pd} = 6.5 \text{ ns (max)} (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$
- Output current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: ±500 mA
- Available in JEDEC SOP, JEITA SOP and TSSOP
- Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 540 type

Note: xxxFW (JEDEC SOP) is not available in Japan. TC74LCX540F SOP20-P-300-1.27A SOP20-P-300-1.27 TC74LCX540FW SOL20-P-300-1.27 TC74LCX540FT TSSOP20-P-0044-0.65A TC74LCX540FK VSSOP20-P-0030-0.50

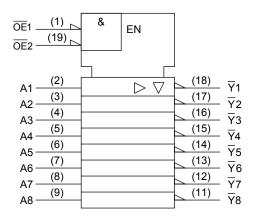
Weight

SOP20-P-300-1.27A : 0.22 g (typ.) SOP20-P-300-1.27 : 0.22 g (typ.) SOL20-P-300-1.27 : 0.46 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

# Pin Assignment (top view)



# **IEC Logic Symbol**



### **Truth Table**

	Inputs	Outputs	
OE1	OE2	An	Outputs
Н	Х	Х	Z
Х	Н	Х	Z
L	L	Н	L
L	L	L	Н

X: Don't care

Z: High impedance



### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Power supply voltage	V <sub>CC</sub>	-0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
		(Note 3)	
Input diode current	I <sub>IK</sub>	-50	mA
Output diode current	I <sub>OK</sub>	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	P <sub>D</sub>	180	mW
DC V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4:  $V_{OUT} < GND, V_{OUT} > VCC$ 

### **Recommended Operating Conditions (Note 1)**

Characteristics	Symbol	Rating	Unit		
Power supply voltage	V <sub>CC</sub>	2.0 to 3.6	V		
Tower supply voltage	vcc	1.5 to 3.6 (Note 2)	V		
Input voltage	V <sub>IN</sub>	0 to 5.5	V		
Output voltage	V	0 to 5.5 (Note 3)	V		
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub> (Note 4)	<b>v</b>		
Output current	I <sub>OH</sub> /I <sub>OI</sub>	±24 (Note 5)	mA		
Output current	IOH/IOL	±12 (Note 6)	IIIA		
Operating temperature	T <sub>opr</sub>	-40 to 85	°C		
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V		

Note 1: The recommended operating conditions are required to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

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Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 6:  $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$ 

Note 7:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V



### **Electrical Characteristics**

### DC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics Symbol		Toot (	Took Condition		Min	May	Unit		
Characteri	Sucs	Symbol	Test Condition		V <sub>CC</sub> (V)	IVIII	Max	Unit	
Input voltage	H-level	V <sub>IH</sub>		_	2.7 to 3.6	2.0	_	V	
input voitage	L-level	V <sub>IL</sub>		_	2.7 to 3.6	_	0.8	v	
				I <sub>OH</sub> = -100 μA	2.7 to 3.6	V <sub>CC</sub> - 0.2	_		
	H-level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OH} = -12 \text{ mA}$	2.7	2.2	_		
				$I_{OH} = -18 \text{ mA}$	3.0	2.4	_		
Output voltage				$I_{OH} = -24 \text{ mA}$	3.0	2.2	_	V	
				I <sub>OL</sub> = 100 μA	2.7 to 3.6	_	0.2		
	V	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	I <sub>OL</sub> = 12 mA	2.7	_	0.4	i		
	L-level	V <sub>OL</sub>	OL VIN = VIH or VIL	$I_{OL} = 16 \text{ mA}$ $I_{OL} = 24 \text{ mA}$	I <sub>OL</sub> = 16 mA	3.0	_	0.4	
					3.0	_	0.55		
Input leakage curren	t	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		2.7 to 3.6	_	±5.0	μА	
3-state output off-sta	ite current	loz	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OLIT} = 0 \text{ to } 5.5 \text{ V}$		2.7 to 3.6	_	±5.0	μА	
Power off leakage cu	urrent	l <sub>OFF</sub>	V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V		0	_	10.0	μА	
	V <sub>IN</sub> = V <sub>CC</sub> or GND		V <sub>IN</sub> = V <sub>CC</sub> or GND		2.7 to 3.6	_	10.0		
Quiescent supply cu	rrent	ICC	V <sub>IN</sub> /V <sub>OUT</sub> = 3.6 to 5.5 V		2.7 to 3.6	_	±10.0	μА	
Increase in I <sub>CC</sub> per in	nput	Δlcc	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V		2.7 to 3.6	_	500		

### AC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Description delegations	t <sub>pLH</sub>	Figure 4 Figure 0	2.7	_	7.5	
Propagation delay time	t <sub>pHL</sub>	Figure 1, Figure 2	$3.3 \pm 0.3$	1.5	6.5	ns
Output anable time	t <sub>pZL</sub>	Figure 1, Figure 3	2.7	_	9.5	ns
Output enable time	t <sub>pZH</sub>	Figure 1, Figure 3	$3.3 \pm 0.3$	1.5	8.5	115
Output disable time	t <sub>pLZ</sub>	Figure 1, Figure 3	2.7	_	8.5	ns
Output disable time	t <sub>pHZ</sub>	rigure 1, rigure 3	$3.3 \pm 0.3$	1.5	7.5	110
Output to output skew	t <sub>osLH</sub>	(Note)	2.7		1	ns
Culput to output skew	t <sub>osHL</sub>	(Note)	$3.3 \pm 0.3$	_	1.0	10

Note: Parameter guaranteed by design.

 $(t_{\text{OSLH}} = |t_{\text{pLHm}} - t_{\text{pLHn}}|, \ t_{\text{OSHL}} = |t_{\text{pHLm}} - t_{\text{pHLn}}|)$ 

### Dynamic Switching Characteristics (Ta = 25°C, input: $t_r = t_f = 2.5$ ns, $C_L = 50$ pF, $R_L = 500$ $\Omega$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	٧
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	٧

## **Capacitive Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	_	3.3	7	pF
Output capacitance	C <sub>OUT</sub>	_	3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	$f_{IN} = 10 \text{ MHz}$ (Note)	3.3	40	pF

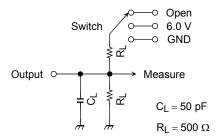
Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 (per bit)$ 

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### **AC Test Circuit**



Parameter	Switch
t <sub>pLH</sub> , t <sub>pHL</sub>	Open
t <sub>pLZ</sub> , t <sub>pZL</sub>	6.0 V
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND

Figure 1

### **AC Waveform**

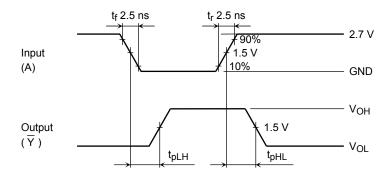


Figure 2 t<sub>pLH</sub>, t<sub>pHL</sub>

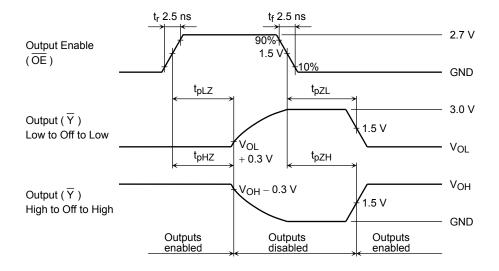
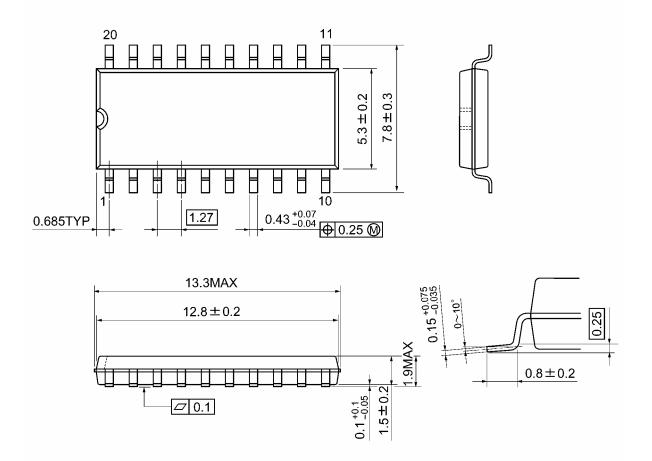


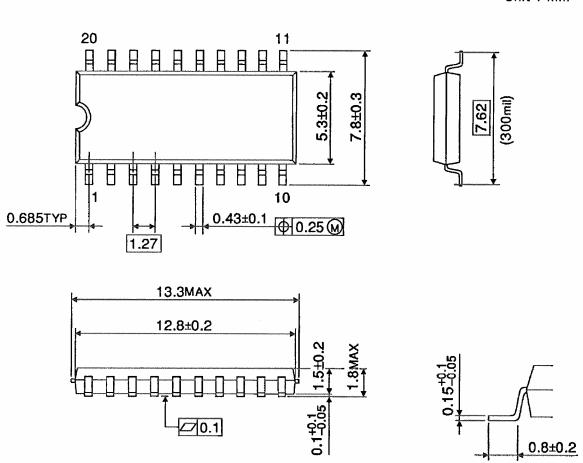
Figure 3  $t_{\text{pLZ}},\,t_{\text{pHZ}},\,t_{\text{pZL}},\,t_{\text{pZH}}$ 

SOP20-P-300-1.27A Unit: mm



Weight: 0.22 g (typ.)

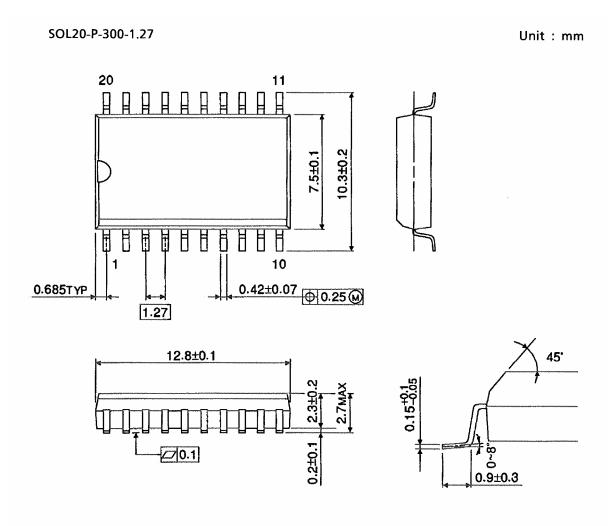
SOP20-P-300-1.27 Unit: mm



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Weight: 0.22 g (typ.)

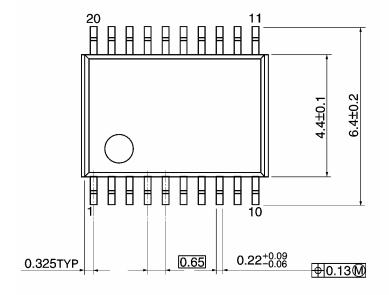
# **Package Dimensions (Note)**

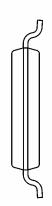


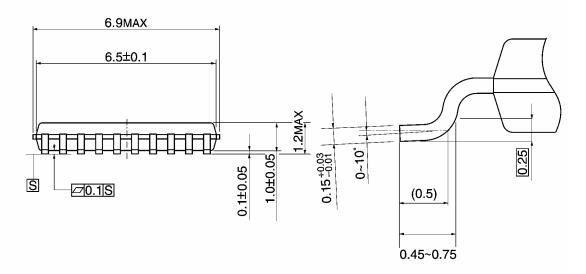
Note: This package is not available in Japan.

Weight: 0.46 g (typ.)

TSSOP20-P-0044-0.65A Unit: mm

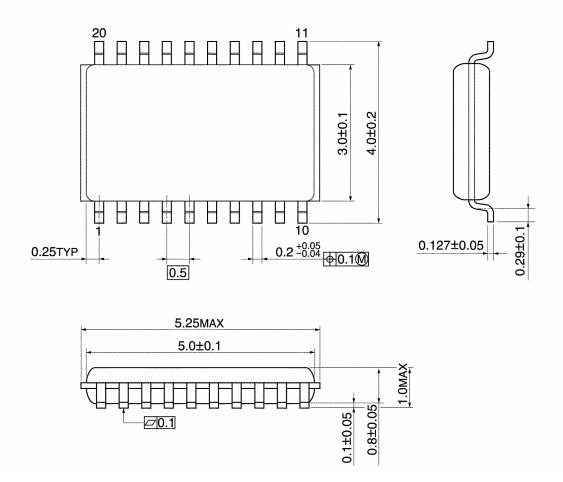






Weight: 0.08 g (typ.)

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)

Note: Lead (Pb)-Free Packages

SOP20-P-300-1.27A TSSOP20-P-0044-0.65A VSSOP20-P-0030-0.50

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